

Supporting information

Vertically Conductive MoS₂ Pyramids with High Density of Active Edge Sites for Efficient Hydrogen Evolution

Qingwei Zhou,^{1,2} Shaoqiang Su,¹ Pengfei Cheng,¹ Xianbao Hu,¹ Xingsen Gao,¹ Zhang Zhang,^{*1} and Jun-Ming Liu^{1,2}

¹ Institute for Advanced Materials and Laboratory of Quantum Engineering and Quantum Materials, South China Academy of Advanced Optoelectronic, Guangzhou 510006, China

² Laboratory of Solid State Microstructures and Innovative Center of Advanced Microstructures, Nanjing University, Nanjing, 210093, China

* Email: zzhang@scnu.edu.cn (Zhang Zhang).

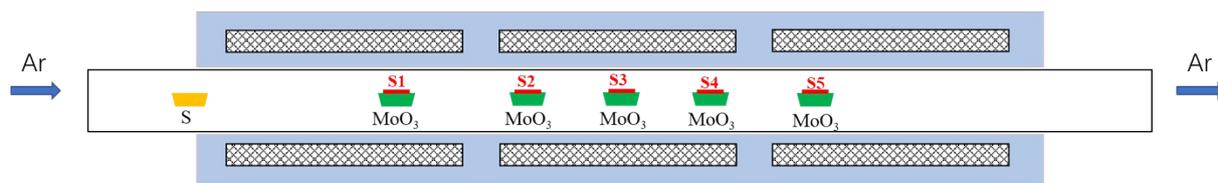


Figure S1. Schematic CVD growth parameters and source distance adjustment for MoS₂ pyramids growth on silica substrates.

The silica substrate was cleaned by acetone, ethanol and DI-water in sequence and dried with nitrogen. Then, the substrate was placed face-down above a crucible containing 3 mg of MoO₃ (99.95%, Aladdin) and loaded into a 4 cm diameter quartz tube three-zone CVD furnace (OTF-1200X). The whole process was performed at atmospheric pressure, using ultra-high-purity Ar (99.999 %) as carrier gas. Another crucible containing 500 mg of sulfur (99.99 %, Aladdin) was located upstream. The distance between the S crucible and the growth substrate was varied to control the morphology of MoS₂ pyramids. The furnace temperature was ramped up to 300 °C with a rate of 20 °C/min and kept constant for 10 min. Then, the temperature was ramped up to 730 °C with a rate of 50 °C/min. After 10 min at 730 °C, the furnace was cooled down with the heater removed. The Ar flow rate was 50 sccm (standard cubic centimeter per minute) when the temperature stayed at 730 °C and 200 sccm during temperature ramp up and the cooling.

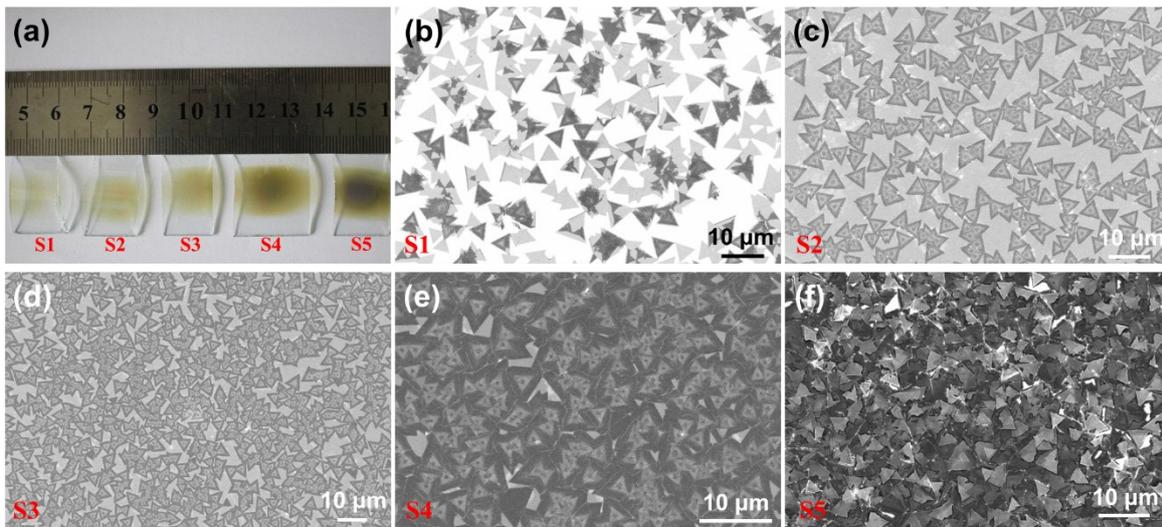


Figure S2. (a) Photograph of five samples placed on different positions (marked in Figure S1) in the tubular furnace with the growth of MoS₂ pyramids by CVD. (b-f) the corresponding SEM images of the five samples (S1, S2, S3, S4 and S5). The distances between the S crucible and this five samples (S1, S2, S3, S4 and S5) are 15, 30, 45, 60 and 75 cm, respectively.

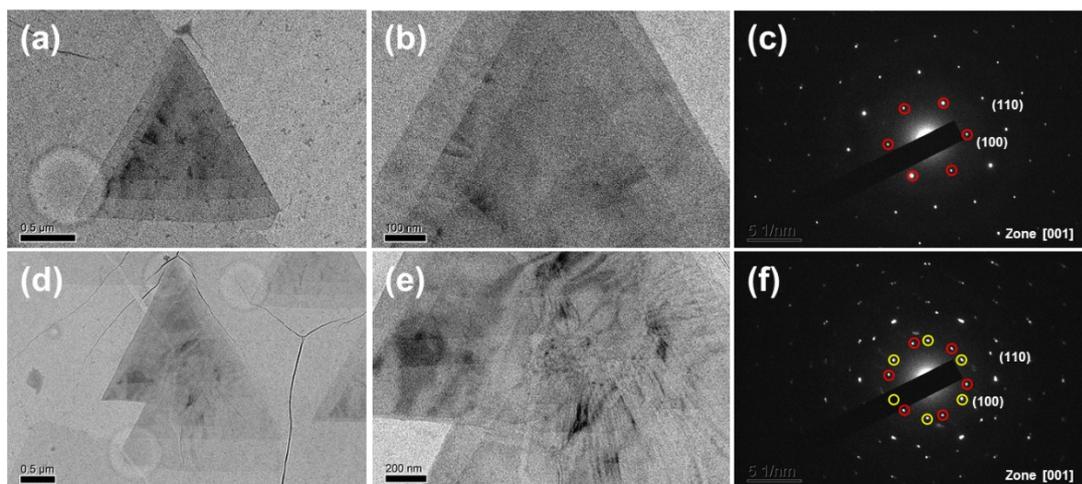


Figure S3. TEM images of (a, b) a dispersed MoS₂ pyramid and (c) the corresponding SAED patterns. TEM images of (d, e) two overlapped MoS₂ pyramids and (c) the corresponding SAED patterns.

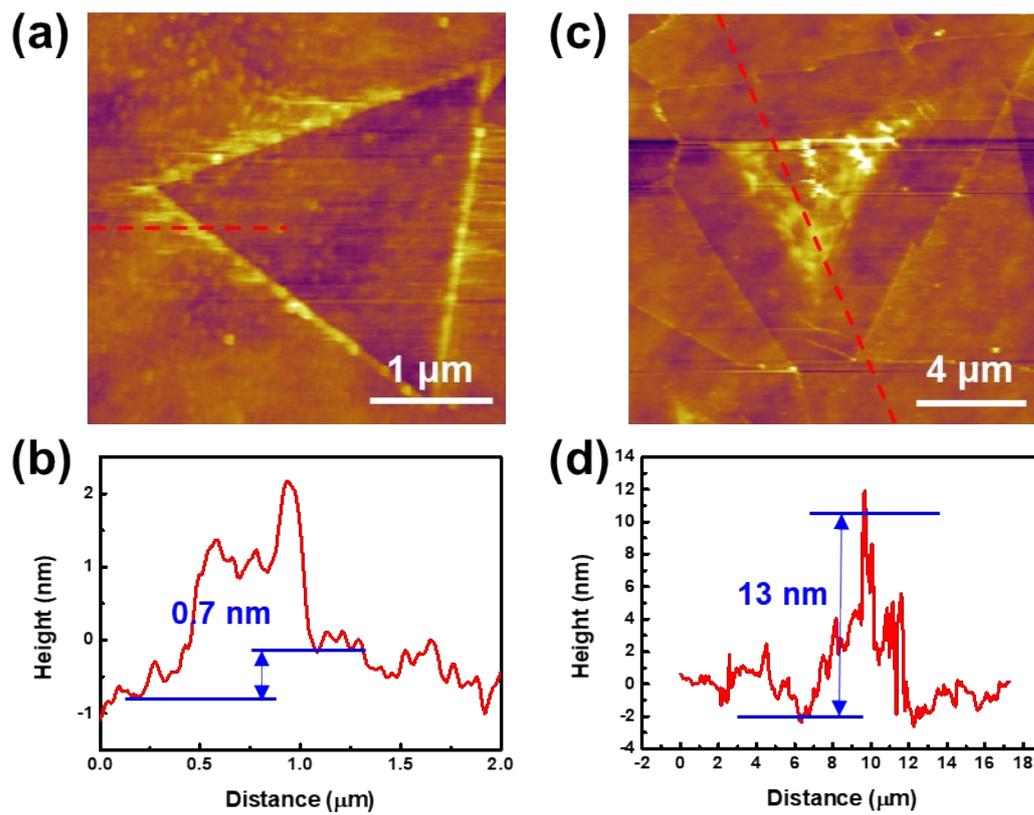


Figure S4. AFM images and the corresponding height profiles of (a, b) a MoS₂ flake and (c, d) a MoS₂ pyramid.

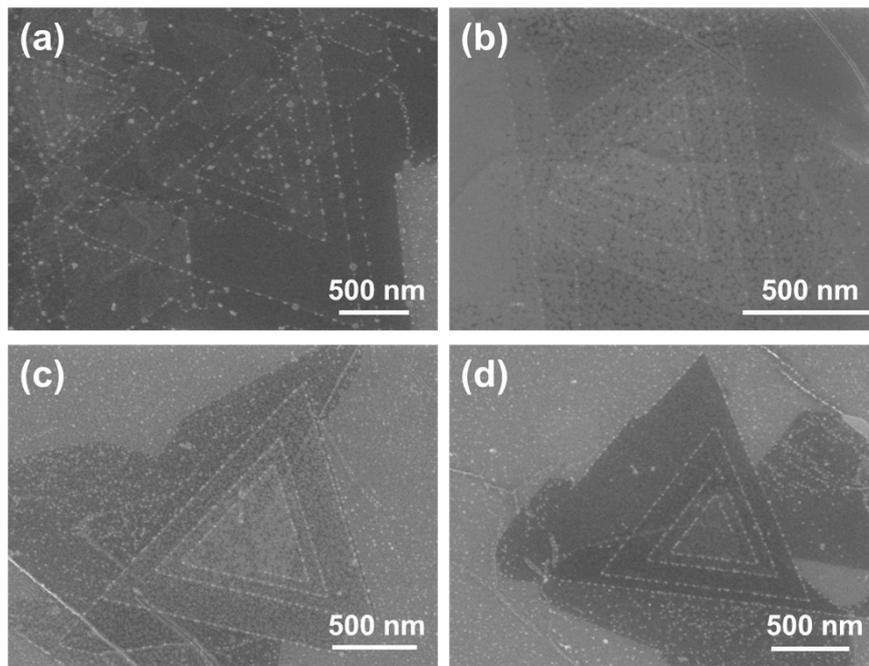


Figure S5. SEM images of MoS₂ pyramids with (a, b) right-handed spiral and (c, d) left-handed spiral.

According to Burton-Cabrera-Frank theory,^[1] spiral dislocations can cause the growth of spiral structures. To form a spiral dislocation core in the MoS₂ spiral, a sliding plane, that is, a spiral defect, needs to be generated at the bottom layer, otherwise the growth will follow the in-plane growth mode and generate a single layer of MoS₂.^[2-4] In our experiments, the occurrence of spiral defects is mainly due to the roughness of the surface of the growth substrate. Under the same growth conditions, MoS₂ grown on SiO₂/Si substrates whose surface can reach atomic smoothness is a single-layer or few-layer structure. Once a spiral dislocation is generated, it will remain active and gradually grow in the vertical direction, because continuous growth at the boundary position of the dislocation center is energetically favorable. At the same time, the exposure boundary continues to grow, and a 60° angle is preferentially formed on each single layer (each rotation is 120° to expose the low-energy zigzag boundary^[5]). Finally, because the upper MoS₂ layer is formed later with a shorter growth time, the upper layer will be smaller, so the whole will grow into a three-dimensional atomic layer spiral pyramid structure.^[2]

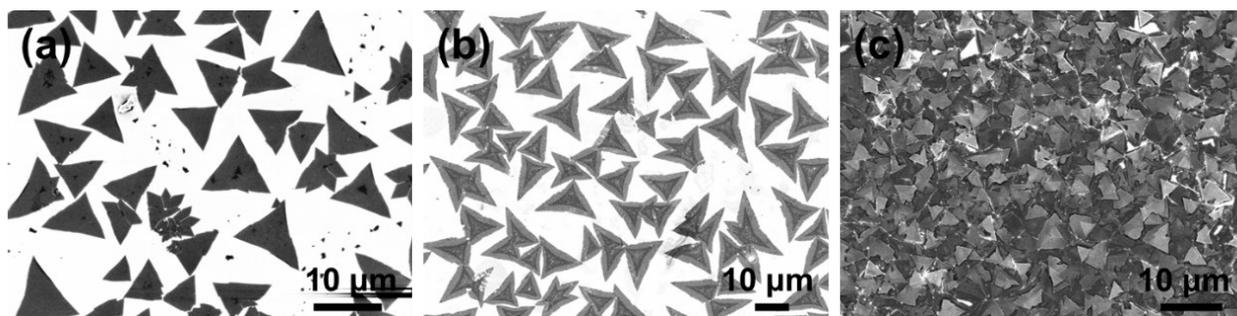


Figure S6. SEM images of (a) monolayer MoS₂ flakes, (b) dispersed MoS₂ pyramids and (c) overlapped MoS₂ pyramids for electrochemical measurements.

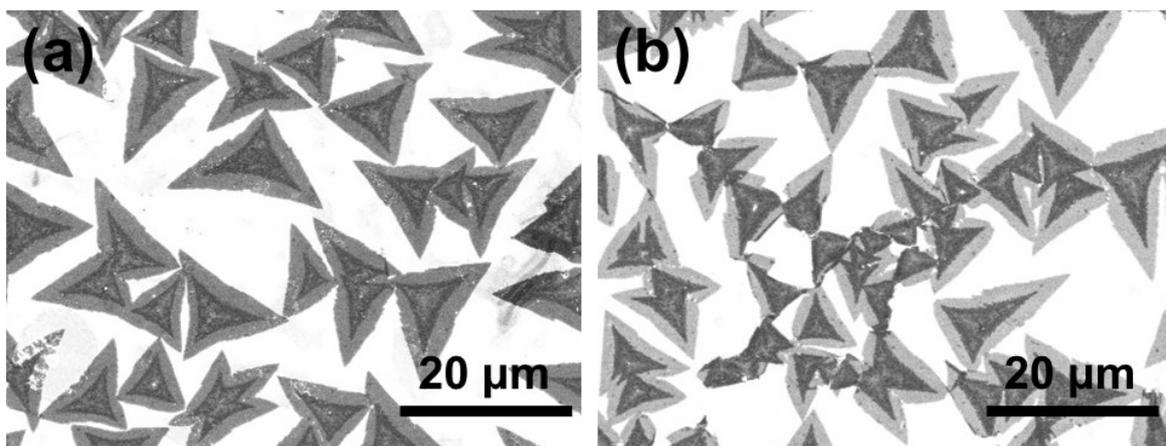


Figure S7. SEM images of dispersed MoS₂ pyramids (a) before and (b) after HER process.

	MoS ₂ pyramids	MoS ₂ pyramids	MoS ₂ flakes
Equivalent circuit			
R_{overall} (Ω)	1.4	2.3	2.2
$R_{\text{ct,dl}}$ (Ω)	22.8	278.6	1628
CPE_{dl} (F)	7.56E-5	5.78E-5	6.03E-5
n_{dl}	0.85	0.91	0.90

Table S1. The fitting results of impedance plots shown in Figure 5 using the equivalent circuit in its inset.

- [1] W. K. Burton, N. Cabrera, F. C. Frank, *Phil. Trans. R. Soc. Lond. A* **1951**, 243, 299.
- [2] L. Zhang, K. Liu, A. B. Wong, J. Kim, X. Hong, C. Liu, T. Cao, S. G. Louie, F. Wang, P. Yang, *Nano Letters* **2014**, 14, 6418.
- [3] S. Najmaei, Z. Liu, W. Zhou, X. Zou, G. Shi, S. Lei, B. I. Yakobson, J.-C. Idrobo, P. M. Ajayan, J. Lou, *Nature Materials* **2013**, 12, 754.
- [4] A. M. van der Zande, P. Y. Huang, D. A. Chenet, T. C. Berkelbach, Y. You, G.-H. Lee, T. F. Heinz, D. R. Reichman, D. A. Muller, J. C. Hone, *Nature Materials* **2013**, 12, 554.
- [5] J. V. Lauritsen, J. Kibsgaard, S. Helveg, H. Topsøe, B. S. Clausen, E. Lægsgaard, F. Besenbacher, *Nature Nanotechnology* **2007**, 2, 53.